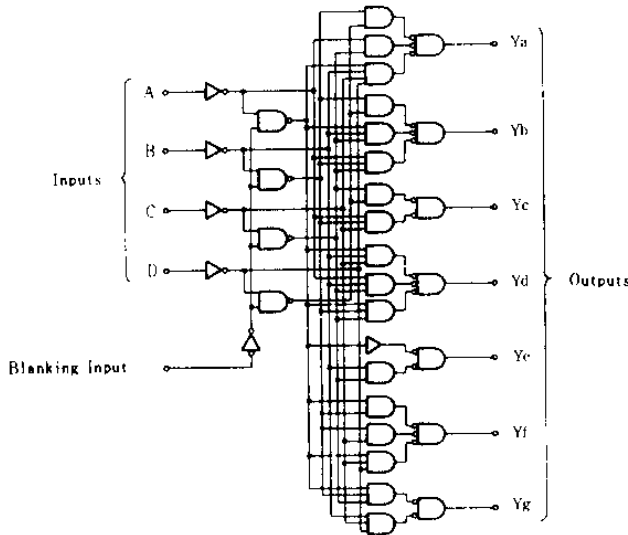


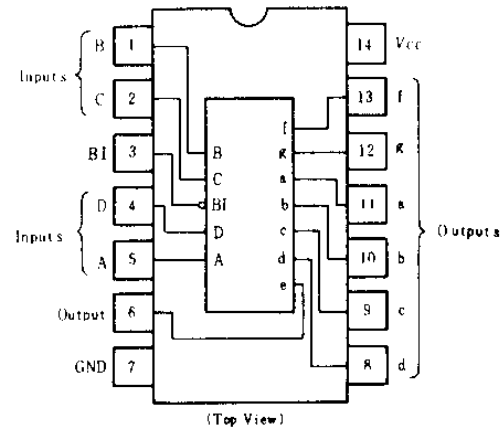
# HD74LS49 • BCD-to-Seven Segment Decoder/Driver (with Open collector outputs)

The HD74LS49 features active-high outputs for driving lamp buffer. This circuit incorporates a direct blanking input. Segment identification and resultant displays are shown below. Display patterns for BCD input counts above 9 are unique symbols to authenticate input conditions. It contains an overriding blanking input (BI) which can be used to control the lamp intensity by pulsing or to inhibit the output. Inputs and outputs are entirely compatible for use with TTL or DTL logic outputs.

## ■ BLOCK DIAGRAM



## ■ PIN ARRANGEMENT



## ■ ABSOLUTE MAXIMUM RATINGS

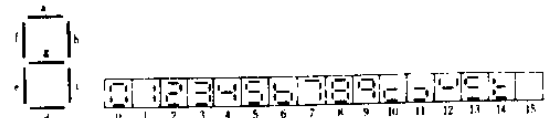
Item	Symbol	Rating	Unit
Supply voltage	$V_{CC}$	7.0	V
Input voltage	$V_{IS}$	7.0	V
Output current (off state)	$I_{O(off)}$	1	mA
Operating temperature range	$T_{opr}$	-20 ~ +75	°C
Storage temperature range	$T_{str}$	65 ~ +150	°C

## ■ FUNCTION TABLE

Decimal or Function	Inputs					Outputs							Note
	D	C	B	A	BI	a	b	c	d	e	f	g	
0	L	L	L	L	H	H	H	H	H	H	H	L	
1	L	L	L	H	H	L	H	H	L	L	L	L	
2	L	L	H	L	H	H	H	L	H	H	L	H	
3	L	L	H	H	H	H	H	H	H	L	L	H	
4	L	H	L	L	H	L	H	H	L	L	H	H	
5	L	H	L	H	H	H	L	H	H	L	H	H	
6	L	H	H	L	H	L	L	H	H	H	H	H	
7	L	H	H	H	H	H	H	H	L	L	L	L	
8	H	L	L	L	H	H	H	H	H	H	H	H	
9	H	L	L	H	H	H	H	H	L	L	H	H	
10	H	L	H	L	H	L	L	L	H	H	L	H	
11	H	L	H	H	H	L	L	H	H	L	L	H	
12	H	H	L	L	H	L	H	L	L	L	H	H	
13	H	H	L	H	H	H	L	L	H	L	H	H	
14	H	H	H	L	H	L	L	L	H	H	H	H	
15	H	H	H	H	H	L	L	L	L	L	L	L	
BI	X	X	X	X	L	L	L	L	L	L	L	L	

H; high level, L; low level, X; irrelevant

- Notes: 1. The blanking input (BI) must be open or held at a high logic level when output functions 0 through 15 are desired.  
2. When a low logic level is applied directly to the blanking input (BI), all segment outputs are low regardless of the level of any other input.



## ELECTRICAL CHARACTERISTICS ( $T_a = -20 \sim +75^\circ\text{C}$ )

Item	Symbol	Test Conditions	min	typ*	max	Unit	
Input voltage	$V_{IH}$		2.0	—	—	V	
	$V_{IL}$		—	—	0.8	V	
Output current	$I_{OH}$	$V_{CC}=4.75\text{V}, V_{IH}=2\text{V}, V_{IL}=0.8\text{V}, V_{OH}=5.5\text{V}$	—	—	250	$\mu\text{A}$	
Output voltage	$V_{OL}$	$V_{CC}=4.75\text{V}, V_{IH}=2\text{V}, V_{IL}=0.8\text{V}$	$I_{OL}=4\text{mA}$	—	—	0.4	V
			$I_{OL}=8\text{mA}$	—	—	0.5	
Input current	$I_{IH}$	$V_{CC}=5.25\text{V}, V_i=2.7\text{V}$	—	—	20	$\mu\text{A}$	
	$I_{IL}$	$V_{CC}=5.25\text{V}, V_i=0.4\text{V}$	—	—	-0.4	mA	
	$I_i$	$V_{CC}=5.25\text{V}, V_i=7\text{V}$	—	—	0.1	mA	
Supply current **	$I_{CC}$	$V_{CC}=5.25\text{V}$	—	8	15	mA	
Input clamp voltage	$V_{IK}$	$V_{CC}=4.75\text{V}, I_{IS}=-18\text{mA}$	—	—	-1.5	V	

\*  $V_{CC}=5\text{V}, T_a=25^\circ\text{C}$

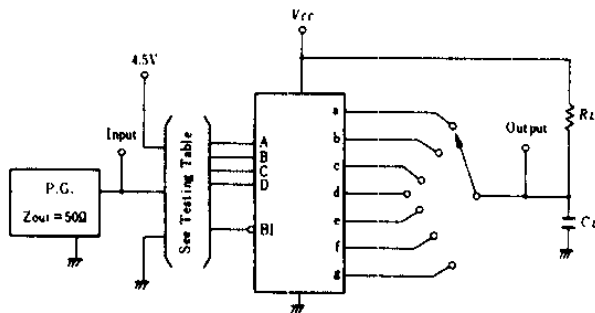
\*\*  $I_{CC}$  is measured with all outputs open and all inputs at 4.5V.

## SWITCHING CHARACTERISTICS ( $V_{CC}=5\text{V}, T_a=25^\circ\text{C}$ )

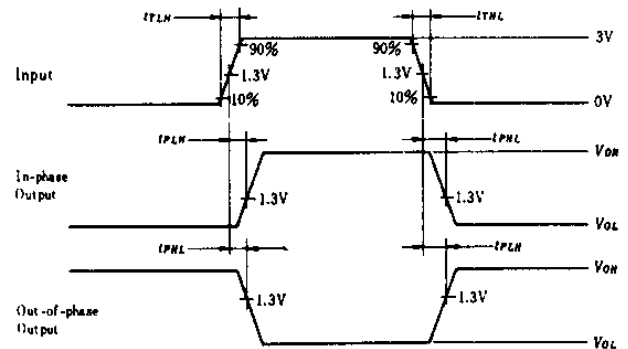
Item	Symbol	Input	Test Conditions	min	typ	max	Unit
Propagation delay time	$t_{PHL}$	A	$C_L=15\text{pF}, R_L=2\text{k}\Omega$	—	—	100	ns
	$t_{PLH}$			—	—	100	
	$t_{PHL}$	BI	$C_L=15\text{pF}, R_L=6\text{k}\Omega$	—	—	100	ns
	$t_{PLH}$			—	—	100	

## TESTING METHOD

### 1) Test Circuit



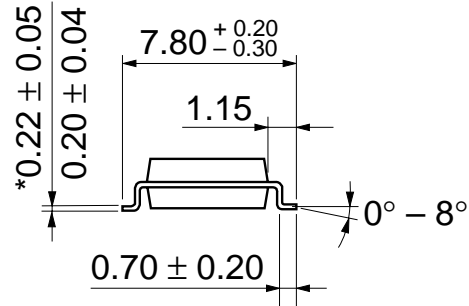
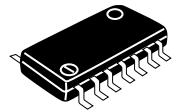
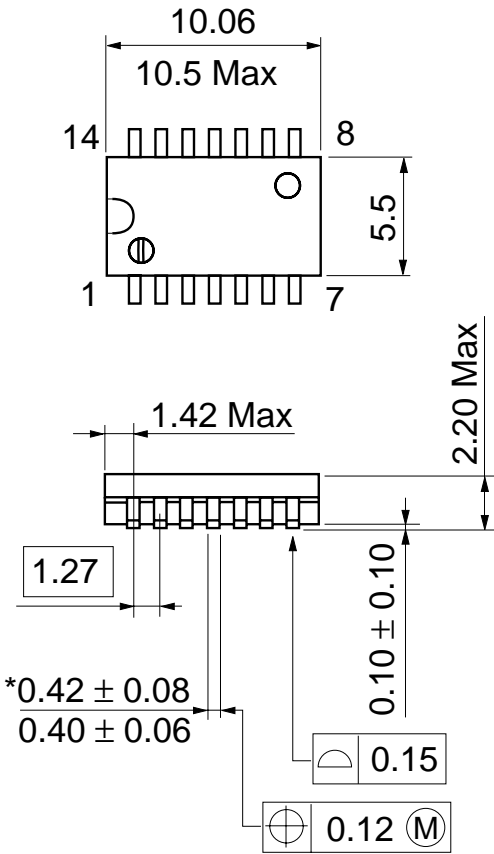
### Waveform



### 2) Testing Table

Item	Inputs					Outputs						
	BI	D	C	B	A	a	b	c	d	e	f	g
$t_{PLH}$	4.5V	GND	GND	GND	IN	OUT	—	—	OUT	OUT	OUT	—
	4.5V	GND	GND	4.5V	IN	—	—	OUT	—	OUT	—	—
$t_{PHL}$	4.5V	GND	4.5V	4.5V	IN	OUT	OUT	—	OUT	OUT	OUT	OUT
	IN	GND	GND	GND	GND	OUT	OUT	OUT	OUT	OUT	OUT	—

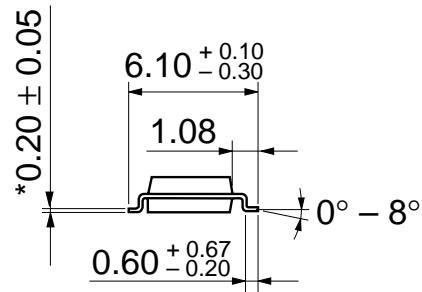
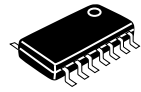
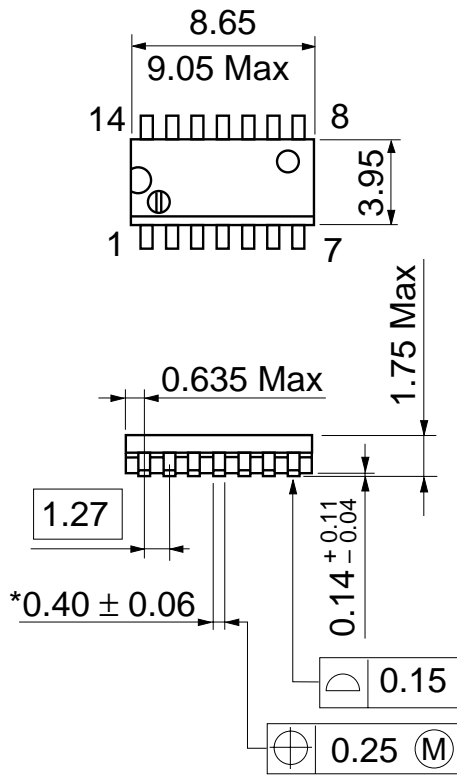
Unit: mm



\*Dimension including the plating thickness  
 Base material dimension

Hitachi Code	FP-14DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.23 g

Unit: mm



Hitachi Code	FP-14DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.13 g

\*Pd plating

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